

A simple model and parameter extraction method for the description of ON-current of LT-PS TFT

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Abstract

A simple SPICE model for the description of the on-current of low-temperature poly-silicon thin film transistors is proposed. By employing constant mobility, V_{GS} dependent alpha parameter, and exponential kink effect, very good agreements between the model and measurement were obtained.

1. Introduction

Low Temperature Poly-Silicon (LT-PS) Thin Film Transistors (TFTs) are expected to play an important role in the next generation flat-panel display technology[1]. In order to use the LT-PS TFTs in semiconductor circuits, an accurate modeling of device characteristics is essential. The most widely used model of LT-PS TFTs are by Jacunski et al which is implemented as HSPICE MOSFET Level 62 (or AIM-SPICE Level 16) [2,3]. Although this model is quite accurate, at least for the description of the DC characteristics, the parameter extraction for this model is quite involved.

In this paper, we propose a very simple analytical model to describe the ON-current behavior of LT-PS TFTs and the parameter extraction technique for the model. By employing V_{GS} -dependent α -parameter, and exponential kink effect, very good agreements between the model and measurement were obtained for the ON-current behavior of short channel devices, where channel length is as short as $4 \mu m$.

2. Results

Above threshold, the drain current in the linear region of poly-silicon TFT can be expressed as

$$I_a = \mu C_{ox} \frac{W}{L} \left[(V_{GS} - V_T) V_{DS} - \frac{V_{DS}^2}{2\alpha} \right], \quad (1)$$

where μ is the carrier mobility, $C_{ox} = \epsilon_{ox} / t_{ox}$ is the gate-oxide capacitance per unit area, where ϵ_{ox} is the dielectric permittivity and t_{ox} is the thickness of the gate oxide. W and L are the channel width and length, respectively. V_{GS} and V_T are gate-source voltage and the threshold voltage, respectively. α is the body-effect related parameter.

If we assume that α , μ and V_T in Eq. (1) are independent of V_{DS} , we can fit the measured I_{DS} (V_{DS}) to the quadratic function of Eq. (2)

$$I_{DS} = AV_{DS} - BV_{DS}^2. \quad (2)$$

when compare Eqs (1) and (2), we can establish following relationship.

$$A = \mu C_{ox} \frac{W}{L} (V_{GS} - V_T), \quad (3a)$$

$$B = \mu C_{ox} \frac{W}{L} \frac{1}{2\alpha}, \quad (3b)$$

$$\frac{A}{B} = 2\alpha(V_{GS} - V_T). \quad (3c)$$

Figure 1 shows the result of the quadratic fitting. We observe that the fitting is very good for small V_{DS} . As the device goes into saturation

with large V_{DS} , the quadratic curves diverge from the measured curves.

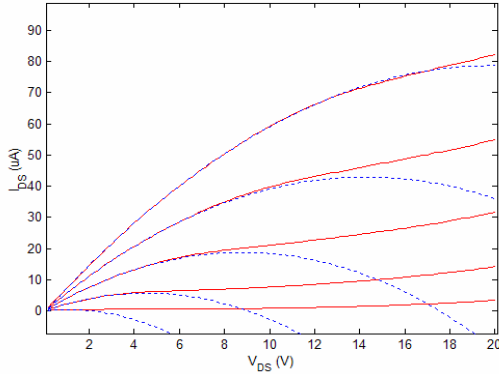


Figure 1. Comparison of the $I_D - V_{DS}$ curves by measurement (solid) and quadratic fitting curve (dotted)

Fig. 2 shows the parameters A and B in Eq. (2) extracted for Fig. 1. From Fig. 2 (a), we can observe that $A(V_{GS})$ is almost straight line. This implies that the carrier mobility can be considered to be a constant for this device. We can extract this constant mobility μ from the slope of the line and V_T from the intercept of this line with the V_{GS} -axis. Next, from Fig. 2 (b), we can observe that α is a strong function of V_{GS} . This is illustrated again in Fig. 2 (c) where $\alpha = (A/2B)/(V_{GS} - V_T)$ is shown (solid line). We can fit α to a quadratic function of V_{GS} as shown in Fig. 2 (c) (dotted line).

In the saturation region, the drain current can be described as,

$$I_{DS} = \alpha \cdot \frac{1}{2} \mu C_{ox} \frac{W}{L} (V_{GS} - V_T)^2. \quad (4)$$

The Eqs (1) and (3) can be combined into one equation as follows[4],

$$I_{DS} = \mu C_{ox} \frac{W}{L} \left[(V_{GS} - V_T) V_{DSe} - \frac{V_{DSe}^2}{2\alpha} \right], \quad (5)$$

where V_{DSe} is effective intrinsic drain-source voltage defined as[5,6]

$$V_{DSe} = \frac{V_{DS}}{\left[1 + \left(\frac{V_{DS}}{V_{sat}} \right)^{M_{SS}} \right]^{\frac{1}{M_{SS}}}}, \quad (6)$$

where V_{sat} is above-threshold saturation voltage given as[7],

$$V_{sat} = 2^{\frac{1}{M_{SS}}} \cdot \alpha \cdot V_{GT}, \quad (7)$$

and M_{SS} is the fitting parameter which controls the transition between the triode region and the saturation region. For long-channel devices, we typically have $M_{SS} \gg 1$ in which case $V_{sat} \approx \alpha \cdot V_{GT}$.

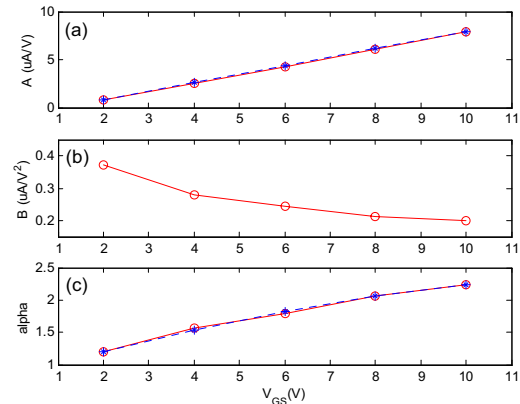


Figure 2. Parameters extracted by parabolic fitting to the linear region $I - V$ curves. (a) A (solid: measurement, dotted: linear fit) (b) B (c) $\alpha = (A/2B)/(V_{GS} - V_T)$ (solid: measurement, dotted: quadratic fit)

Figure 3 shows modeled $I_{DS} - V_{DS}$ curves which calculated with takes the saturation effect into consideration[3]. We can observe that the agreement between the measurement (solid line) and the model (dotted line) is quite good in the

linear region. However, for large V_{DS} , the agreement between them is poor. This is due to kink effect.

We define multiplication factor M due to kink effect as the ratio of measured I_{DS} to the calculated I_{DS} not including the kink effect.

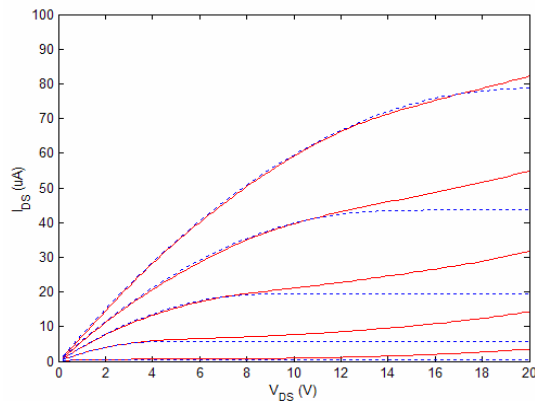


Figure 3. Comparison of the $I_D - V_{DS}$ curves by measurement (solid) and the modeling not including the kink effect (dotted)

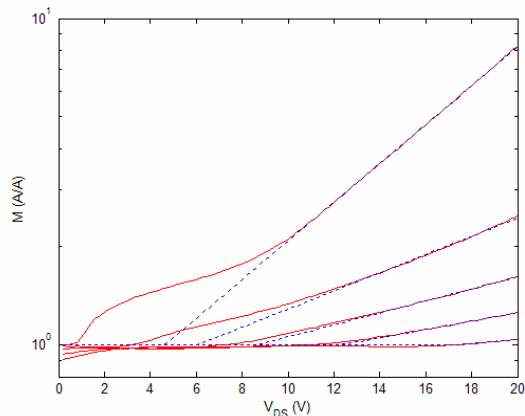


Figure 4. Current multiplication factor M defined as the ratio of measured I_{DS} to the modeled I_{DS} not including the kink effect (solid). Dotted lines represent exponential fit in the large V_{DS} region.

Figure 4 shows the multiplication factor M obtained from the I_{DS} curves in Fig. 3. We can observe that M is a strong function of both V_{GS} and V_{DS} , and for large values of V_{DS} , M can be modeled as

$$M = C \exp(D \cdot V_{DS}), \quad (8)$$

where C and D are functions of V_{GS} . The dotted lines in Fig. 4 represent the result of this exponential function fitting.

Figure 5 (a) compares the I_{DS} curves calculated using the above kink effect model with the measured curves. We can observe excellent agreements between the curves. Fig. 5 (b) shows the output conductance of the TFT defined as $g_{DS} = \partial I_{DS} / \partial V_{DS}$. The output resistances obtained by numerically differentiating the measured data and modeled one agree very well both in the linear region and the saturation region.

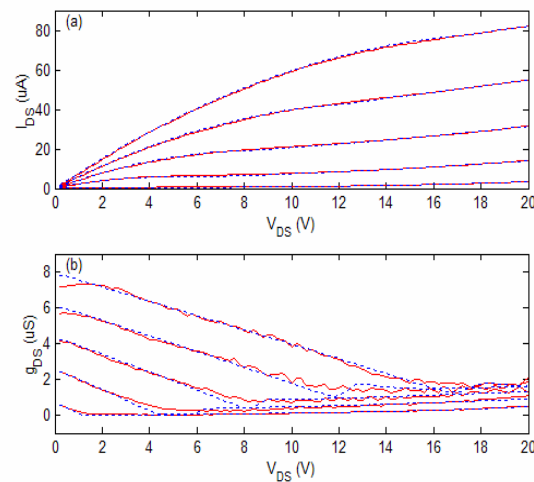


Figure 5. (a) Comparison of $I_D - V_{DS}$ curves from measurement (solid) and modeling (dotted) (b) Output resistance by numerically differentiating the $I_D - V_{DS}$ curves from the measurement (solid) and modeling (dotted)

3. Conclusions

In conclusion, we proposed a very simple model for the description of on-current behavior of LT-PS TFTs. The parameter extraction technique is very straightforward and does not involve any nonlinear optimization. By employing constant mobility, V_{GS} dependent α - parameter, and exponential kink effect, a very good agreement between the model and measurement was obtained.

4. Acknowledgements

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5. References

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